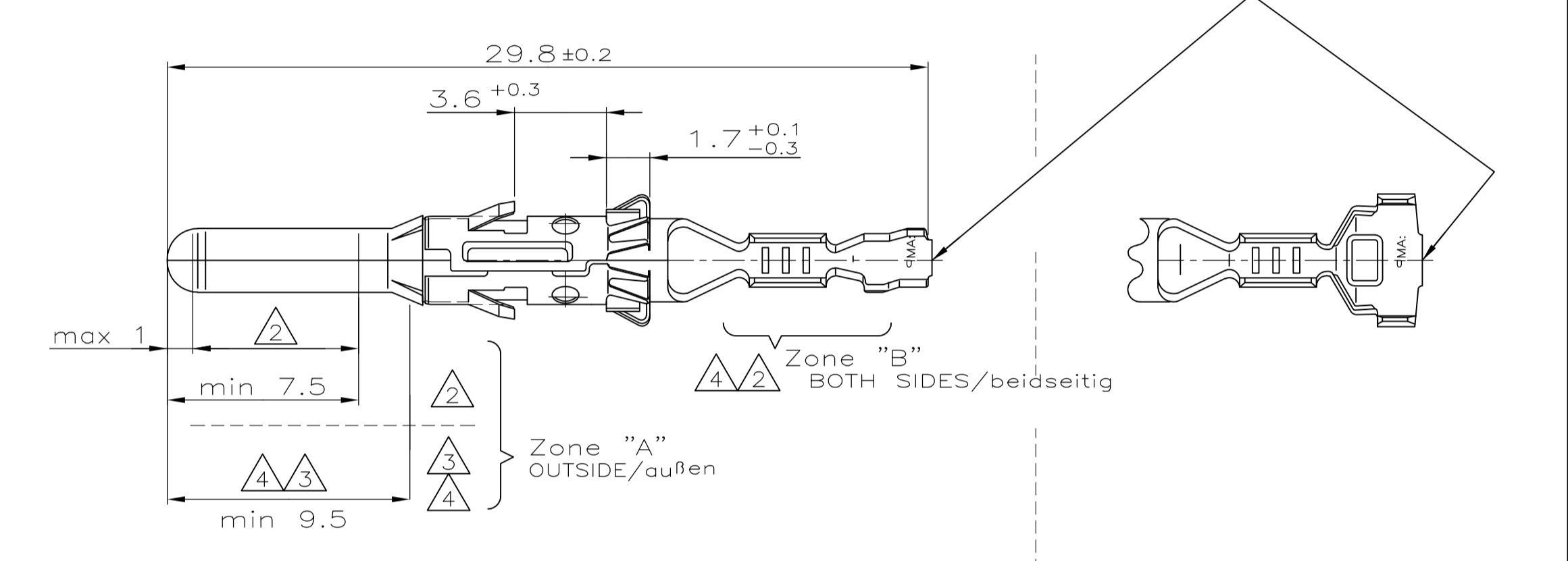


Version B (SINGLE WIRE SEAL-SYSTEM / Einzel-Dichtungs-System)	Dwg. No.	Rev.	Material	Surface	DGB [mm²]	Wire Crimp	Insul.-Crimp	Wire Crimp Height	Application Tool	Hand Tool	TE CONNECTIVITY	TE CONNECTIVITY	A	B	C	
											ORDER-Nr.	ORDER-Nr.				
FLR	1-929968-0	1-962972-0	M	CuFe2	2	>1.0-2.5	E = 3.6 G = 3.8 D _{cr} = 1.7	H = 5.0 K = 5.0 D = 3.6	2.5mm² = 1.97 2.0mm² = 1.82 1.5mm² = 1.67	MQC-Applicator 2-878486-2	734289-2	4	6.9	8.5	828921-1	828922-1
	929968-9	962972-9	M	CuNiSi	3											
	929968-8	962972-8	M	CuNiSi	2											
	929968-7	962972-7	M	CuNiSi	3											
	929968-4	962972-4	M	CuFe2	1											
	929968-1	962972-1	M	CuNiSi	1											
	1-929967-4	1-962971-4	A	CuNiSi	4											
	1-929967-0	1-962971-0	M	CuFe2	2											
	929967-9	962971-9	M	CuNiSi	3											
	929967-8	962971-8	M	CuNiSi	2											
FLR	929967-7	962971-7	M	CuNiSi	3	0.5-1.0	E = 2.6 G = 2.8 D _{cr} = 1.1	H = 4.8 K = 4.8 D = 3.2	1.0mm² = 1.45 0.75mm² = 1.36 0.5mm² = 1.27	MQC-Applicator 2-878485-2	734289-1	3	5.4	7	828920-1	828922-1
	929967-4	962971-4	M	CuFe2	1											
	929967-1	962971-1	M	CuNiSi	1											
	1-929966-0	1-962970-0	M	CuFe2	2											
	929966-9	962970-9	M	CuNiSi	3											
	929966-8	962970-8	M	CuNiSi	2											
	929966-7	962970-7	M	CuNiSi	3											
	929966-4	962970-4	M	CuFe2	1											
	929966-1	962970-1	M	CuNiSi	1											



Version A (UNSEALED / ungedichtet)	Dwg. No.	Rev.	Material	Surface	DGB [mm²]	Wire Crimp	Insul.-Crimp	Wire Crimp Height	Application Tool	Hand Tool	TE CONNECTIVITY	TE CONNECTIVITY	A	B	C								
											ORDER-Nr.	ORDER-Nr.											
FLR	1-929965-0	1-962969-0	J	CuFe2	2	>2.5-4.0	E = 4.3 G = 4.5 D _{cr} = 2.4	H = 5.4 K = 5.6 D = 3.2	4.0mm² = 2.30 3.0mm² = 2.05	MQC-Applicator 2-878483-2	734285-3	4	5.5	8.5									
	929965-9	962969-9	J	CuNiSi	3																		
	929965-8	962969-8	J	CuNiSi	2																		
	929965-7	962969-7	J	CuNiSi	3																		
	929965-4	962969-4	J	CuFe2	1																		
	929965-1	962969-1	J	CuNiSi	1																		
	1-929964-0	1-962968-0	J	CuFe2	2																		
	929964-9	962968-9	J	CuNiSi	3																		
	929964-8	962968-8	J	CuNiSi	2																		
	929964-7	962968-7	J	CuNiSi	3																		
FLR	929964-4	962968-4	J	CuFe2	1	>1.0-2.5	E = 3.6 G = 3.8 D _{cr} = 1.7	H = 4.3 K = 4.5 D = 2.6	2.5mm² = 1.97 2.0mm² = 1.82 1.5mm² = 1.67 1.25mm² = 1.60	MQC-Applicator 2-878482-2	734285-2	4	5.5	8.5									
	929964-1	962968-1	J	CuNiSi	1																		
	1-929963-0	1-962967-0	L	CuFe2	2																		
	929963-9	962967-9	L	CuNiSi	3																		
	929963-8	962967-8	L	CuNiSi	2																		
	929963-7	962967-7	L	CuNiSi	3																		
	929963-4	962967-4	L	CuFe2	1																		
	929963-1	962967-1	L	CuNiSi	1																		
	1-929962-0	1-962966-0	J	CuFe2	2										0.2-0.4	E = 2.1 G = 2.1 D _{cr} = 0.8	H = 2.5 K = 2.5 D = 1.4	0.35mm² = 1.11 0.25mm² = 1.07 0.2mm² = 1.05	MQC-Applicator 2-878480-2	734285-1	3	4.5	7
	929962-9	962966-9	J	CuNiSi	3																		
929962-8	962966-8	J	CuNiSi	2																			
929962-7	962966-7	J	CuNiSi	3																			
929962-4	962966-4	J	CuFe2	1																			
929962-1	962966-1	J	CuNiSi	1																			

REMARKS
Bemerkungen

1 **PRE TINNED** 1-2µm vorverzint

2 **ZONE "A":** MIN 0.8µm ELECTROPL. Au OVER MIN 1.3µm ELECTROPL. Ni LAYER
min 0.8µm galv. Au über min 1.3µm galv. Ni
ZONE "B": 1-2µm ELECTROPL. Sn OVER MIN 0.1µm ELECTROPL. Ni
1-2µm galv. Sn über min 0.1µm galv. Ni
REST: min 0.1µm ELECTROPL. Ni
min 0.1µm galv. Ni

3 **ZONE "A":** MIN 3µm ELECTROPL. Ag
min 3µm galv. Ag
REST: min 0.5µm ELECTROPL. Ag
min 0.5µm galv. Ag

4 **ZONE "A":** MIN 3µm ELECTROPL. Ag
min 3µm galv. Ag
ZONE "B": 1-3µm ELECTROPL. Sn
1-3µm galv. Sn
REST: SILVER OR TIN ALLOWED IN TRANSITION AREAS.OVERLAPPING LAYERS
AND PLAIN SURFACES ARE NOT ALLOWED.
Silber oder Zinn im Übergangsbereich erlaubt.
überlagernde Schichten oder blanke Stellen sind nicht erlaubt.

5 **AT AREA OF TOP OPENING PERMITTED**
Im Bereich der Spitze Öffnung zulässig

6 **AVAILABILITY MUST BE CHECKED BY TE CONNECTIVITY**
Verfügbarkeit ist von TE CONNECTIVITY zu prüfen

TE CONNECTIVITY ORDER-Nr.	TE CONNECTIVITY ORDER-Nr.	REV.	MATERIAL Werkstoff	SURFACE Oberfläche	DGB [mm²]	WIRE CRIMP Drahtcrimp	INSUL.-CRIMP Isol.-Crimp	WIRE CRIMP HEIGHT CH Drahtcrimp-Höhe CH	APPLICATION TOOL Anschlag-WKZ	HAND TOOL Handzange	A	B	C
STRIP FORM Bandware	LOOSE PIECE Einzelausführung					CRIMP DIMENSION (mm) Crimpabmessungen (mm)			EXTRACTION TOOL Ausdrückwerkzeug Nr.: 872070-1				

THIS DRAWING IS A CONTROLLED DOCUMENT. DIESE ZEICHNUNG IST EIN KONTROLLIERTES DOKUMENT.		DIN C. Goeltz 25-JUN-2001		TE Connectivity	
DIMENSIONS: DIMENSIONEN mm		CIK J. Granzow 25-JUN-2001		NAME	
TOLERANCES UNLESS OTHERWISE SPECIFIED: ALLES IN TOLERANZEN		APVD	PRODUCT SPEC PRODUKTSPEZ		
0-RIBS ± 0.15 mm			108-18027		
1-PLC ± -			APPLICATION SPEC VERARBEITUNGSPEZ		
2-PLC ± -			114-18020		
3-PLC ± -			WEIGHT GEWICHT		
4-PLC ± -			0.85 g		
ANGLES / WINKEL ± 1°			CUSTOMER DRAWING / KUNDENZEICHNUNG		
MATERIAL SEE TABLE			SCALE MASSSTAB 5:1		
			SHEET OF 1 VON 1		
			REV A4		